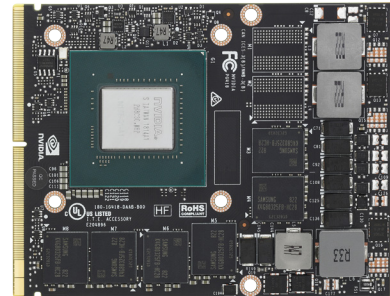


EGX-MXM-P3000 Preliminary

Mobile PCI Express Module with NVIDIA® Quadro® Embedded P3000

Features

- Standard MXM 3.1 Type B form factor (82mm x 105 mm)
- 1280 CUDA cores
- 3.9 TFLOPS peak FP32 performance
- 6GB GDDR5 memory, 192-bit
- 168GB/s peak memory bandwidth
- Maximum power 75W
- 5-year availability



Introduction

Meeting the needs of embedded, ruggedized, and mobile system builders, the EGX-MXM-P3000 is specifically purposed to accommodate form factors incompatible with conventional PCI Express cards, and is built to maintain operations under a wide range of thermal and other environmental conditions. It's the ideal choice for blade-based and other deployments where high GPU density is critical, with a choice of GPU memory capacity, extremely reasonable power requirements, and flexible display options.

Ordering Information

- **EGX-MXM-P3000**
 NVIDIA® Quadro® Embedded P3000 , MXM 3.1 type B,
 82 x 105mm, PCIe x16 Gen3
 * The product is recommended to use with PIS-5500.

Specifications

	EGX-MXM-P3000
Graphic Core	
GPU	Quadro® P3000
Memory	6GB GDDR5 memory, 192-bit, Bandwidth: 168.2 GB/s
GPGPU Computing	
CUDA Cores	1280 CUDA® cores, 3.9 TFLOPS peak FP32 Performance
Compute API	CUDA Toolkit 8.0, CUDA Compute version 6.1, OpenCL™ 1.2, Direct Compute
Graphics API	DirectX® 12, OpenGL 4.5, Vulkan 1.0 Shader Model 5.1
Display	
Display Outputs	4x DisplayPort 1.4 digital video outputs (DP++), 1x HDMI, 2x DVI, 1x eDP
Interface	MXM 3.1, PCI Express Gen3 x16 support
Mechanicals	
Dimensions	82 (W) x 105 (D) x 4.8 (H) mm
Form Factor	Standard MXM 3.1 Type B
Environmental	
Operating Temp.	0°C to 55°C
Storage Temp.	-40°C to 125°C
Module Power Consumption	75W
SW Support	
OS Support	Windows 10 & Linux drivers, 64-bit